

WP1384AD/GD

3.4mm Single-Level Circuit Board Indicator

DESCRIPTION

• The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

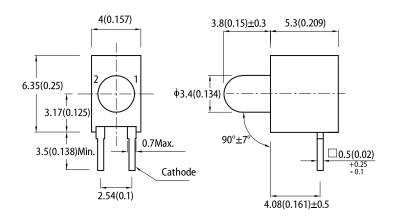
FEATURES

- · Ideal for card edge status indication
- · High reliability-life measured in years
- Housing UL rating: 94V-0
- · Housing material: Type 66 nylon
- · RoHS compliant

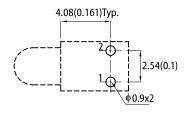
APPLICATIONS

- Status indicator
- Illuminator
- · Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

PACKAGE DIMENSIONS



Recommended PCB Layout



- 1. All dimensions are in millimeters (inches)
- 1. Air unimissions are in minimiseters (inches).
 2. Tolerance is ±0.25(0.01") unless otherwise noted.
 3. Lead spacing is measured where the leads emerge from the package.
 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SELECTION GUIDE

Part Number	Emitting Color	Lens Type Iv (mcd) @ 10mA [2]	Iv (mcd) @ 10mA [2]		Viewing Angle [1]
Part Number	(Material)		Тур.	201/2	
WP1384AD/GD	□ Green (GaP)	Green Diffused	10	20	60°

Notes.

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Parameter	Symbol	Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 10mA	λ_{peak}	Green	565	-	nm
Dominant Wavelength I _F = 10mA	λ _{dom} ^[1]	Green	568	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 10mA	Δλ	Green	30	-	nm
Capacitance	С	Green	15	-	pF
Forward Voltage I _F = 10mA	V _F ^[2]	Green	2	2.4	V
Reverse Current (V _R = 5V)	I _R	Green	-	10	μА

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
 Forward voltage:±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P _D	62.5	mW	
Reverse Voltage	V_R	5	V	
Junction Temperature	T _j	110	°C	
Operating Temperature	T _{op}	-40 to +85	°C	
Storage Temperature	T _{stg}	-40 to +85	°C	
DC Forward Current	l _F	25	mA	
Peak Forward Current	I _{FM} ^[1]	140	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Lead Solder Temperature [2]		260°C For 3 Seconds		
Lead Solder Temperature [3]		260°C For 5 Seconds		

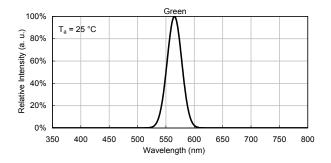
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



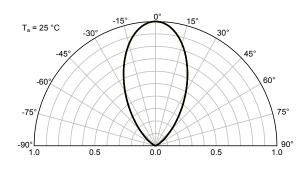


TECHNICAL DATA

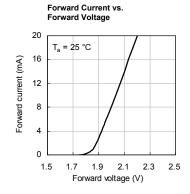
RELATIVE INTENSITY vs. WAVELENGTH

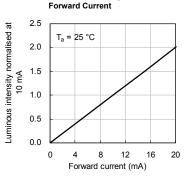


SPATIAL DISTRIBUTION

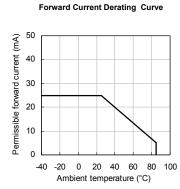


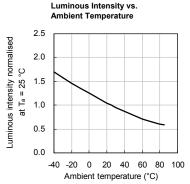
GREEN



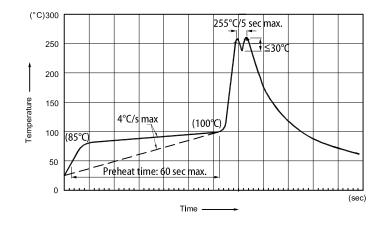


Luminous Intensity vs.





RECOMMENDED WAVE SOLDERING PROFILE



- Notes:
 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath
- temperature of 260°C

 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- Do not apply stress to the epoxy resin while the temperature is above 85°C.
 Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended.

PACKING & LABEL SPECIFICATIONS







